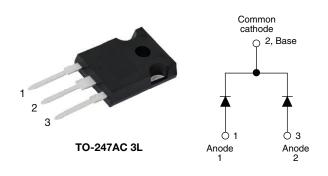
Ultrafast Rectifier, 2 x 30 A FRED Pt[®]



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PRIMARY CHARACTERISTICS								
I _{F(AV)}	2 x 30 A							
V _R	400 V							
V _F at I _F	0.92 V							
t _{rr} typ.	37 ns							
T _J max.	175 °C							
Package	TO-247AC 3L							
Circuit configuration	Common cathode							

FEATURES

- Low forward voltage drop
- 175 °C operating junction temperature
- Ultrafast recovery time
- Low leakage current
- Designed and qualified according to JEDEC[®]-JESD 47



- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

VS-60CPU04... series are the state of the art ultrafast recovery rectifiers designed with optimized performance of forward voltage drop and ultrafast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, welding, UPS, DC/DC converters as well as freewheeling diodes in low voltage inverters, and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Peak repetitive reverse voltage	V _{RRM}		400	V					
Average rectified forward current	F(A)A	Rated V _R , T _C = 134 °C	30						
per device			60	А					
Non-repetitive peak surge current per leg	I _{FSM}	T _J = 25 °C, t _p = 10 ms	300	~					
Peak repetitive forward current per leg	I _{FM}	Rated V _R , square wave, 20 kHz, T _C = 134 $^{\circ}$ C	60						
Operating junction and storage temperatures	T _J , T _{Stg}		-65 to +175	°C					

ELECTRICAL SPECIFICATIONS ($T_J = 25 \text{ °C}$ unless otherwise specified)									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	400	-	-				
Forward voltage	V _F	I _F = 30 A	-	1.10	1.30	v			
		I _F = 30 A, T _J = 150 °C	= 150 °C - 0.92		1.10	v			
		I _F = 60 A	-	1.25	1.6				
		I _F = 60 A, T _J = 150 °C	-	1.10	1.4				
Poweree leekage ourrept	I _R	$V_{R} = V_{R}$ rated	-	-	10				
Reverse leakage current		$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	100	μA			
Junction capacitance	CT	V _R = 400 V	-	40	-	pF			
Series inductance	L _S	Measured lead to lead 5 mm from package body	-	12	-	nH			

 Revision: 09-Oct-2018
 1
 Document Number: 93189

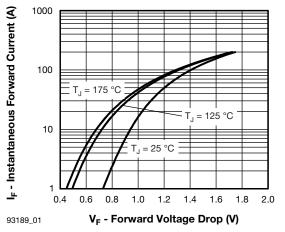
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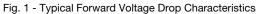
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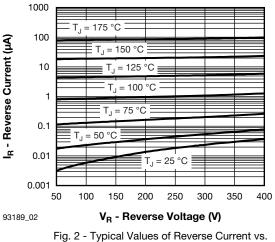


DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25$ °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS			
Reverse recovery time		$I_F = 1.0 \text{ A}, \text{ di}_F/\text{dt} = 100$) A/µs, V _R = 30 V	-	37	40				
	t _{rr}	$I_F = 1.0 \text{ A}, \text{ di}_F/\text{dt} = 50$	-	46	-					
		T _J = 25 °C		-	65	-	ns			
		T _J = 125 °C		-	119	-				
Deals recover sourcent	I _{RRM}	T _J = 25 °C	$I_{\rm F} = 30 {\rm A}$	-	6.4	-	A			
Peak recovery current		T _J = 125 °C	di _F /dt = 200 A/µs V _B = 200 V	-	14.7	-				
Reverse recovery charge	Q _{rr}	T _J = 25 °C] ``	-	206	-				
		T _J = 125 °C		-	874	-	no			

THERMAL - MECHANICAL SPECIFICATIONS										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Maximum junction and storage temperature range	T _J , T _{Stg}		-65	-	+175	°C				
Thermal resistance, junction to case per leg	R _{thJC}		-	0.6	1.0					
Thermal resistance, junction to ambient per leg		Typical socket mount	-	-	40	°C/W				
Thermal resistance, case to heatsink	R _{thCS}	Mounting surface, flat, smooth, and greased	-	0.5	-					
Weight			-	6	-	g				
weight			-	0.21	-	oz.				
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)				
Marking device		Case style TO-247AC 3L	60CPU04							







Reverse Voltage

VS-60CPU04-N3

Vishay Semiconductors

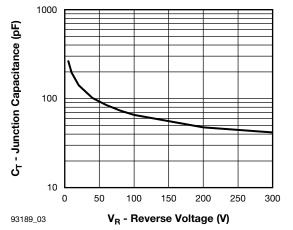


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

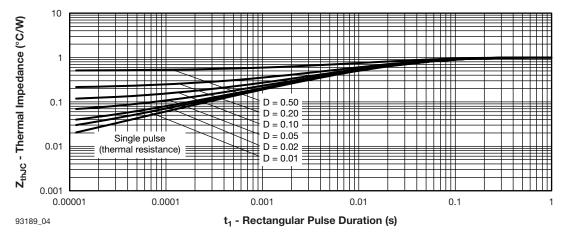
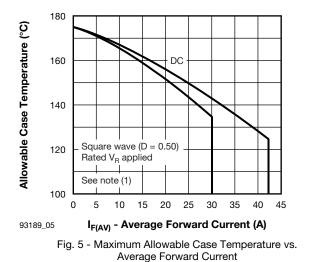
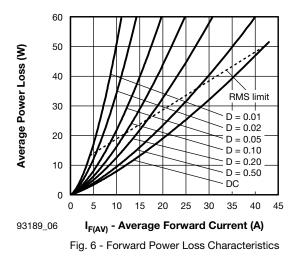


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics



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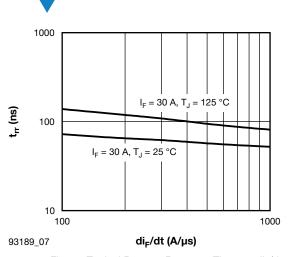
 $I_F = 30 \text{ A}, \text{ } \text{T}_J = 25 \ ^\circ\text{C}$

1000

I_F = 30 A, T_J = 125 °C

di_F/dt (A/µs)

Fig. 8 - Typical Stored Charge vs. di_F/dt



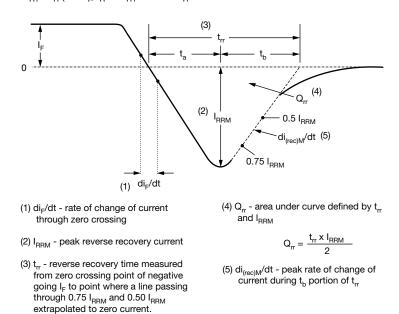
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Fig. 7 - Typical Reverse Recovery Time vs. di_F/dt

Note

SHA

- Formula used: $T_C = T_J (Pd + Pd_{REV}) \times R_{thJC}$; (1) Pd = forward power loss = $I_{F(AV)} \times V_{FM}$ at ($I_{F(AV)}/D$) (see fig. 6);
 - Pd_{REV} = inverse power loss = $V_{R1} \times I_R (1 D)$; I_R at V_{R1} = rated V_R



10 000

1000

100

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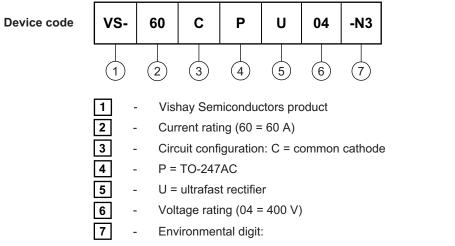
100

Qrr (nC)

Fig. 9 - Reverse Recovery Waveform and Definitions



ORDERING INFORMATION TABLE



-N3 = halogen-free, RoHS-compliant and totally lead (Pb)-free

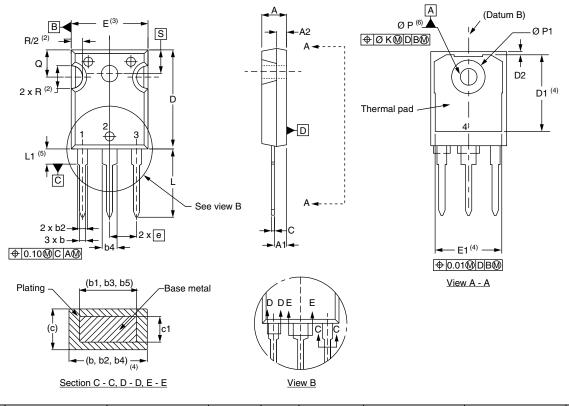
ORDERING INFORMATION (Example)									
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION						
VS-60CPU04-N3	25	500	Antistatic plastic tube						

LINKS TO RELATED DOCUMENTS						
Dimensions <u>www.vishay.com/doc?96138</u>						
Part marking information	www.vishay.com/doc?95007					
SPICE model	www.vishay.com/doc?95398					



TO-247AC 3L

DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	IETERS	INC	HES	NOTES	NOTES	NOTES	SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES		STWDOL	MIN.	MAX.	MIN.	MAX.	NOTES	
A	4.65	5.31	0.183	0.209			D2	0.51	1.35	0.020	0.053		
A1	2.21	2.59	0.087	0.102			E	15.29	15.87	0.602	0.625	3	
A2	1.17	1.37	0.046	0.054			E1	13.46	-	0.53	-		
b	0.99	1.40	0.039	0.055			е	5.46	BSC	0.215	5 BSC		
b1	0.99	1.35	0.039	0.053			ØК	0.2	254	0.0)10		
b2	1.65	2.39	0.065	0.094			L	14.20	16.10	0.559	0.634		
b3	1.65	2.34	0.065	0.092			L1	3.71	4.29	0.146	0.169		
b4	2.59	3.43	0.102	0.135			ØΡ	3.56	3.66	0.14	0.144		
b5	2.59	3.38	0.102	0.133			Ø P1	-	7.39	-	0.291		
С	0.38	0.89	0.015	0.035			Q	5.31	5.69	0.209	0.224		
c1	0.38	0.84	0.015	0.033			R	4.52	5.49	0.178	0.216		
D	19.71	20.70	0.776	0.815	3		S	5.51	BSC	0.217	' BSC		
D1	13.08	-	0.515	-	4								

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994

(2) Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

(4) Thermal pad contour optional with dimensions D1 and E1

⁽⁵⁾ Lead finish uncontrolled in L1

⁽⁶⁾ Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

⁽⁷⁾ Outline conforms to JEDEC[®] outline TO-247 with exception of dimension Q

Revision: 20-Jun-17

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